

P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)
- 40	0.010 at V _{GS} = - 10 V	- 16.1	33 nC
	0.014 at V _{GS} = - 4.5 V	- 13.3	



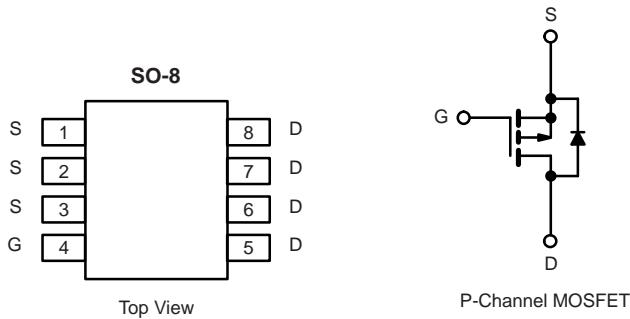
RoHS
COMPLIANT
HALOGEN
FREE

FEATURES

- Halogen-free According to IEC 61249-2-21
Definition
- 100 % R_g Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Load Switch
- POL



ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted				
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 40	V	
Gate-Source Voltage	V _{GS}	± 20		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	- 16.1	A	
	T _C = 70 °C	- 12.9		
	T _A = 25 °C	- 10.2 ^{b, c}		
	T _A = 70 °C	- 8.2 ^{b, c}		
Pulsed Drain Current	I _{DM}	- 50		
Continous Source-Drain Diode Current	T _C = 25 °C	- 5.3		
	T _A = 25 °C	- 2.1 ^{b, c}		
Single Pulse Avalanche Current	I _{AS}	- 28		
Single Pulse Avalanche Energy	E _{AS}	39	mJ	
Maximum Power Dissipation	T _C = 25 °C	6.3	W	
	T _C = 70 °C	4		
	T _A = 25 °C	2.5 ^{b, c}		
	T _A = 70 °C	1.6 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	37	50
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	16	20

Notes:

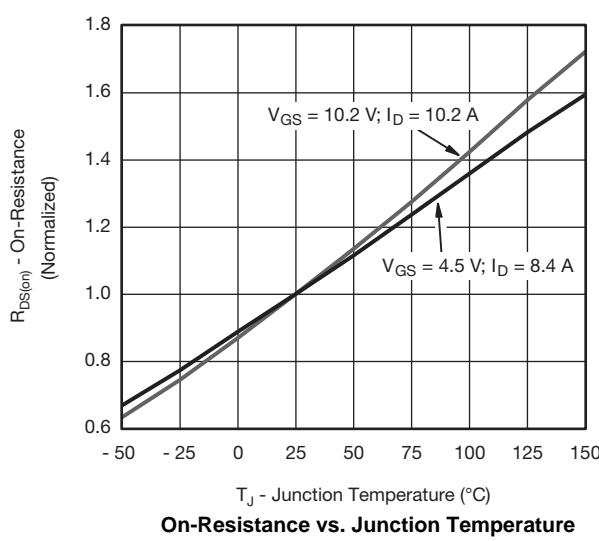
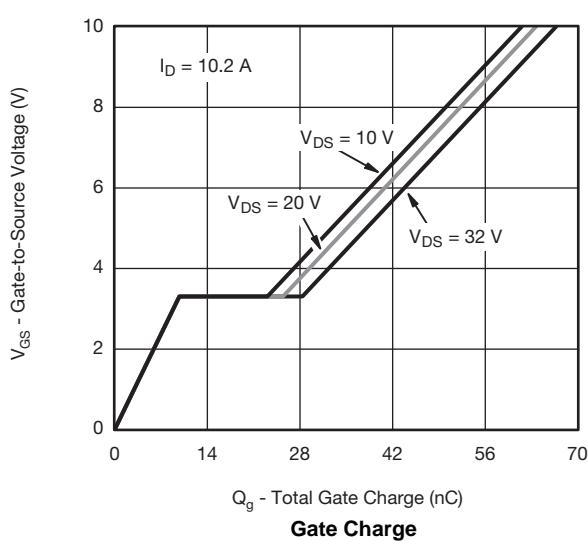
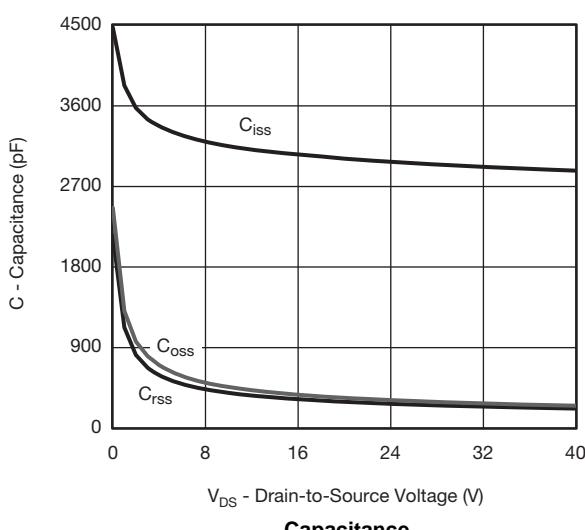
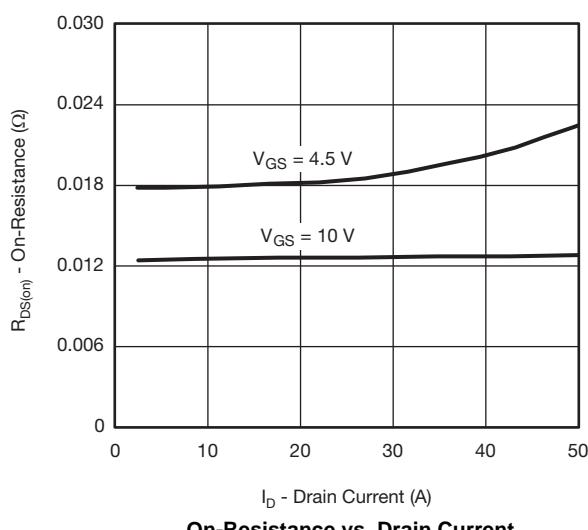
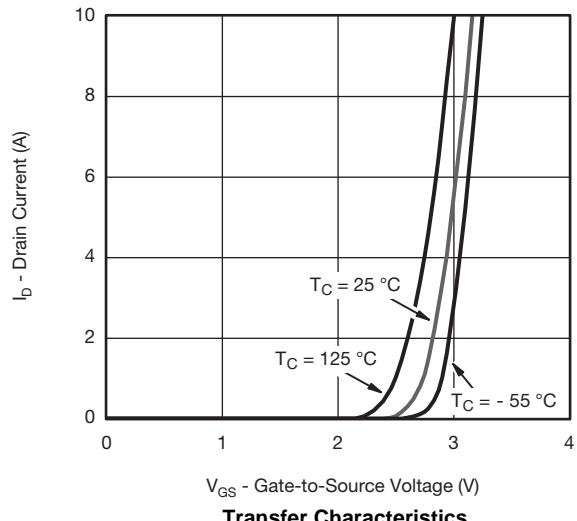
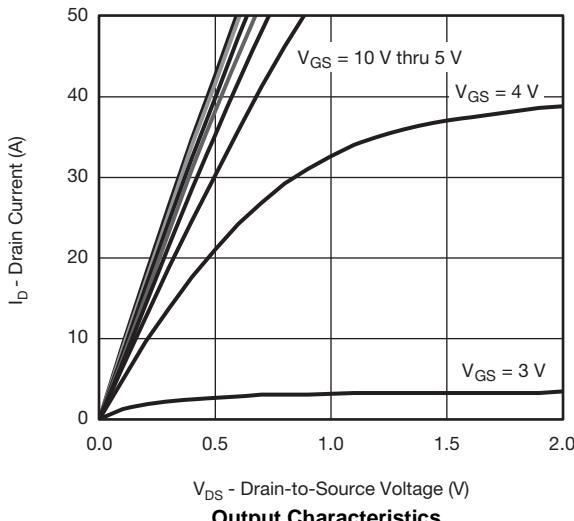
- Based on T_C = 25 °C.
- Surface mounted on 1" x 1" FR4 board.
- t = 10 s.
- Maximum under steady state conditions is 85 °C/W.

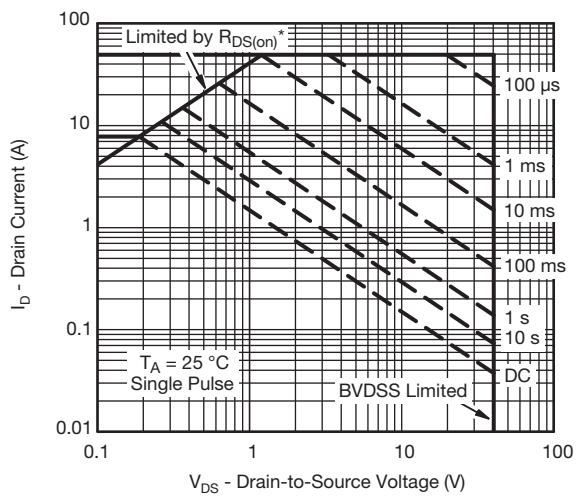
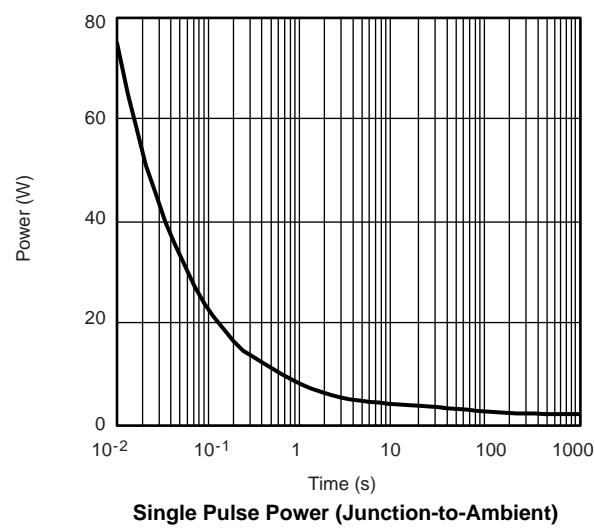
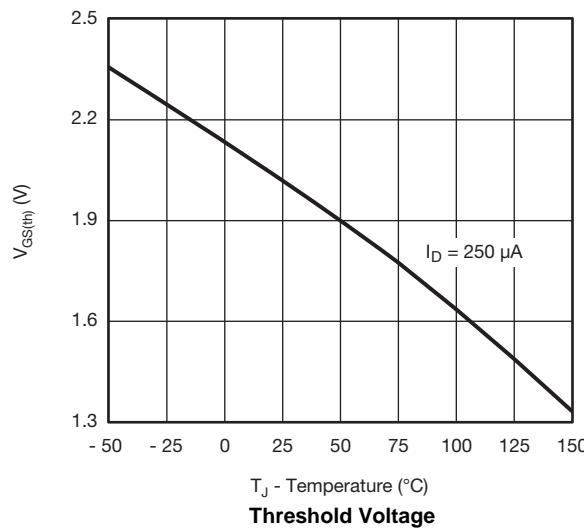
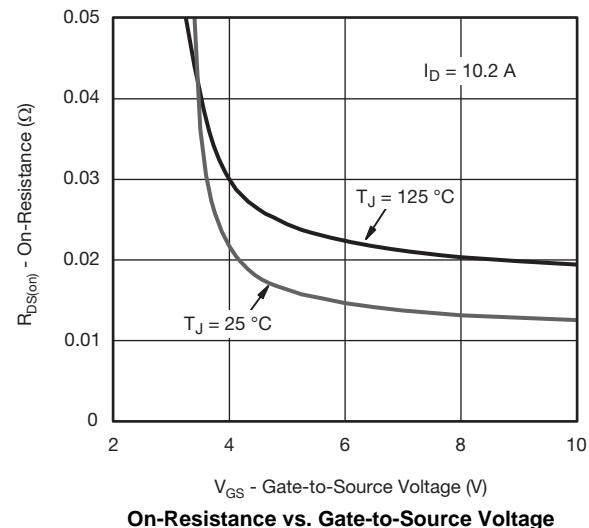
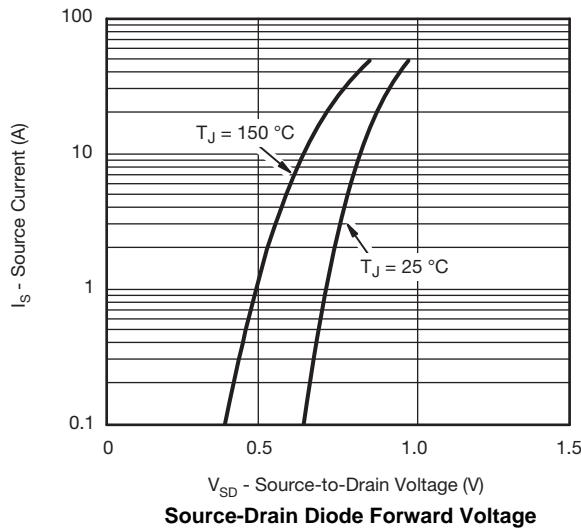
SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-40			V	
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = -250 \mu\text{A}$		-36		mV/°C	
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$			5			
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-1.2		-2.5	V	
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA	
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$			-5		
On-State Drain Current ^a	$I_{D(\text{on})}$	$V_{DS} \leq -5 \text{ V}, V_{GS} = -10 \text{ V}$	-25			A	
Drain-Source On-State Resistance ^a	$R_{DS(\text{on})}$	$V_{GS} = -10 \text{ V}, I_D = -10.2 \text{ A}$		0.010		Ω	
		$V_{GS} = -4.5 \text{ V}, I_D = -8.4 \text{ A}$		0.014			
Forward Transconductance ^a	g_{fs}	$V_{DS} = -15 \text{ V}, I_D = -10.2 \text{ A}$		37		S	
Dynamic^b							
Input Capacitance	C_{iss}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		3007		pF	
Output Capacitance	C_{oss}			335			
Reverse Transfer Capacitance	C_{rss}			291			
Total Gate Charge	Q_g	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10.2 \text{ A}$		64	95	nC	
Gate-Source Charge	Q_{gs}			33	50		
Gate-Drain Charge	Q_{gd}			9.8			
Gate Resistance	R_g			15.7			
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = -20 \text{ V}, R_L = 2.4 \Omega$ $I_D \approx -8.2 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		0.4	2	4	Ω
Rise Time	t_r			57	86	ns	
Turn-Off Delay Time	$t_{d(\text{off})}$			50	75		
Fall Time	t_f			40	60		
Turn-On Delay Time	$t_{d(\text{on})}$			17	26		
Rise Time	t_r			13	20		
Turn-Off Delay Time	$t_{d(\text{off})}$			11	20		
Fall Time	t_f			45	68		
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I_S	$T_C = 25^\circ\text{C}$			-5.3	A	
Pulse Diode Forward Current	I_{SM}				-50		
Body Diode Voltage	V_{SD}	$I_S = -8.2 \text{ A}, V_{GS} = 0 \text{ V}$		-0.8	-1.2	V	
Body Diode Reverse Recovery Time	t_{rr}	$I_F = -8.2 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}, T_J = 25^\circ\text{C}$		36	54	ns	
Body Diode Reverse Recovery Charge	Q_{rr}			41	62	nC	
Reverse Recovery Fall Time	t_a			20		ns	
Reverse Recovery Rise Time	t_b			16			

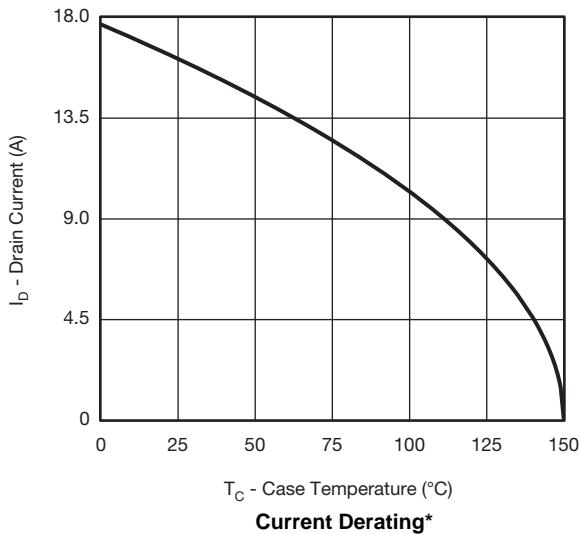
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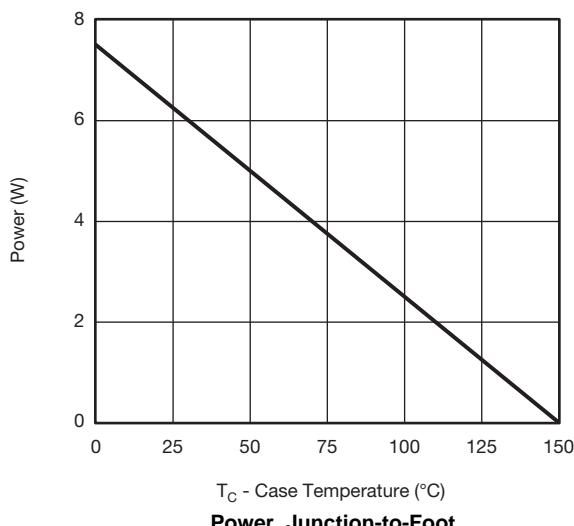
- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

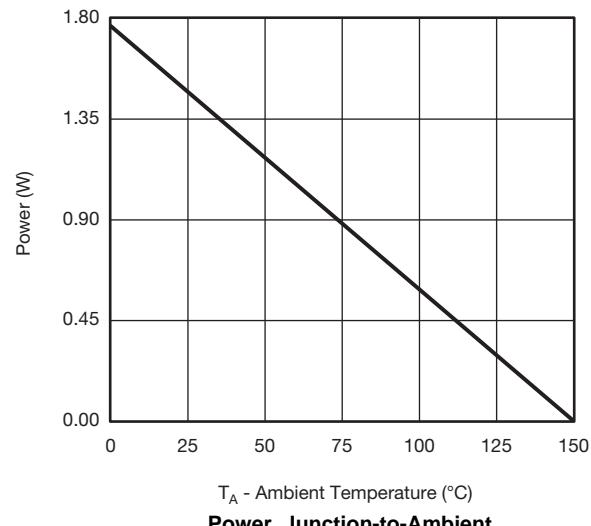
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted


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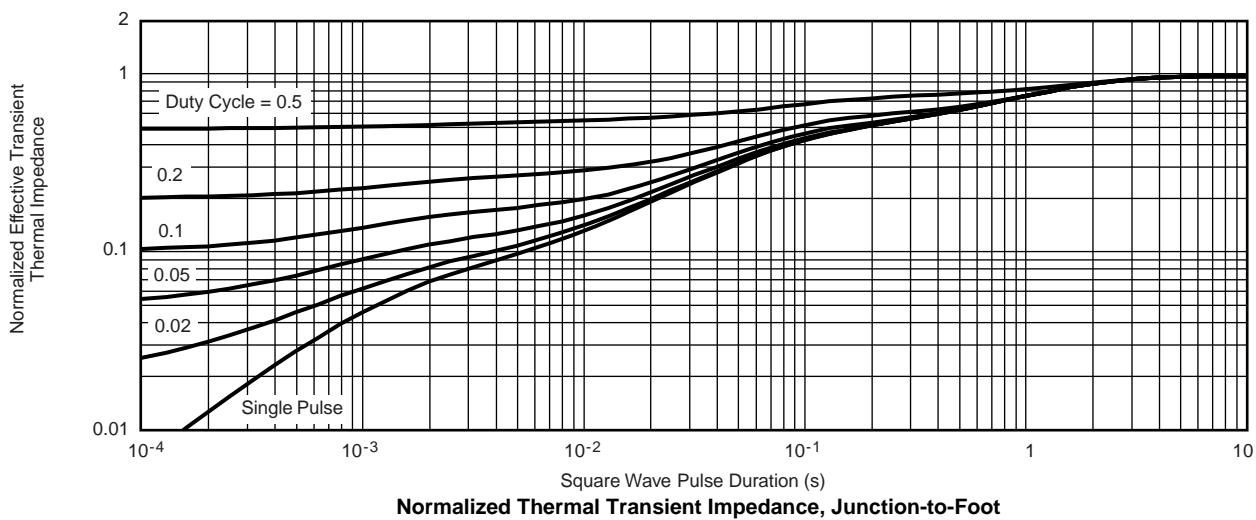
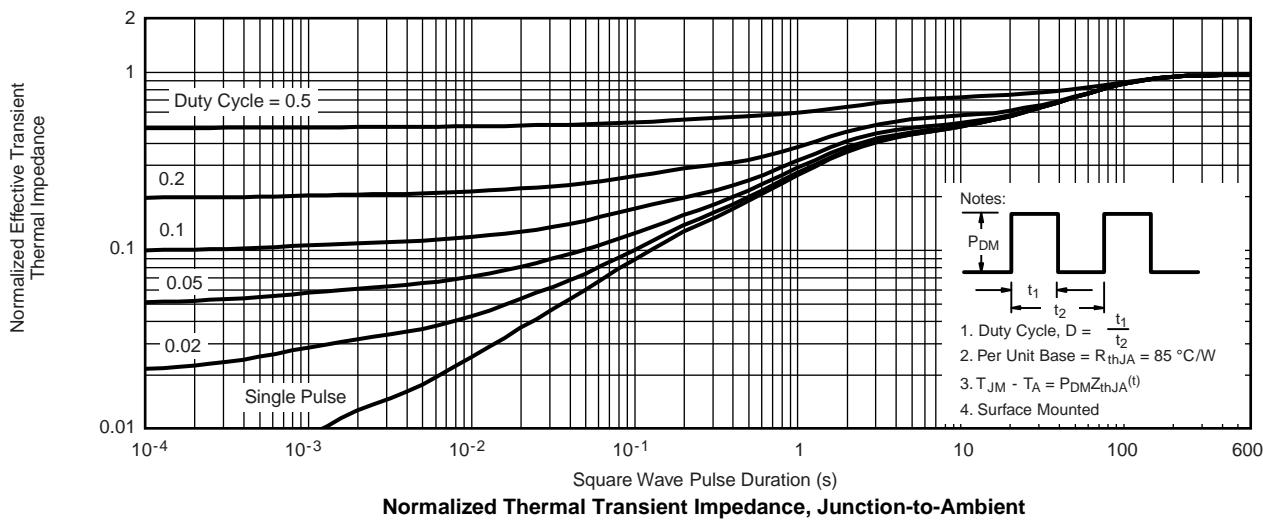
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

 T_C - Case Temperature (°C)

Current Derating*

 T_C - Case Temperature (°C)

Power, Junction-to-Foot

 T_A - Ambient Temperature (°C)

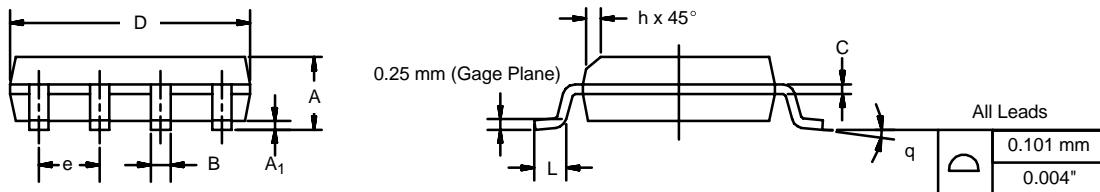
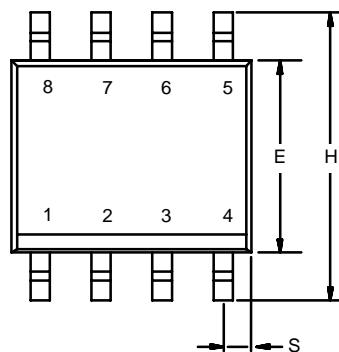
Power, Junction-to-Ambient

* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted


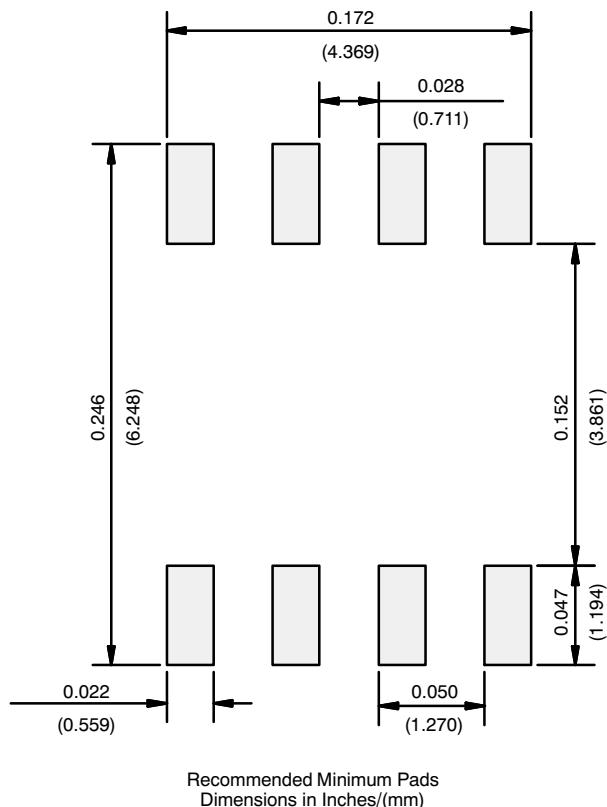
SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012



DIM	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A ₁	0.10	0.20	0.004	0.008
B	0.35	0.51	0.014	0.020
C	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°
S	0.44	0.64	0.018	0.026

ECN: C-06527-Rev. I, 11-Sep-06
DWG: 5498

RECOMMENDED MINIMUM PADS FOR SO-8

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